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Renesas Electronics Corporation

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# H8/300H Tiny Series

## Four-Digit BCD Multiplication (MULD)

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### Introduction

Multiplies two four-digit BCD (binary-coded-decimal) numbers and places the result (eight-digit BCD) in general registers.

### Target Device

H8/300H Tiny Series

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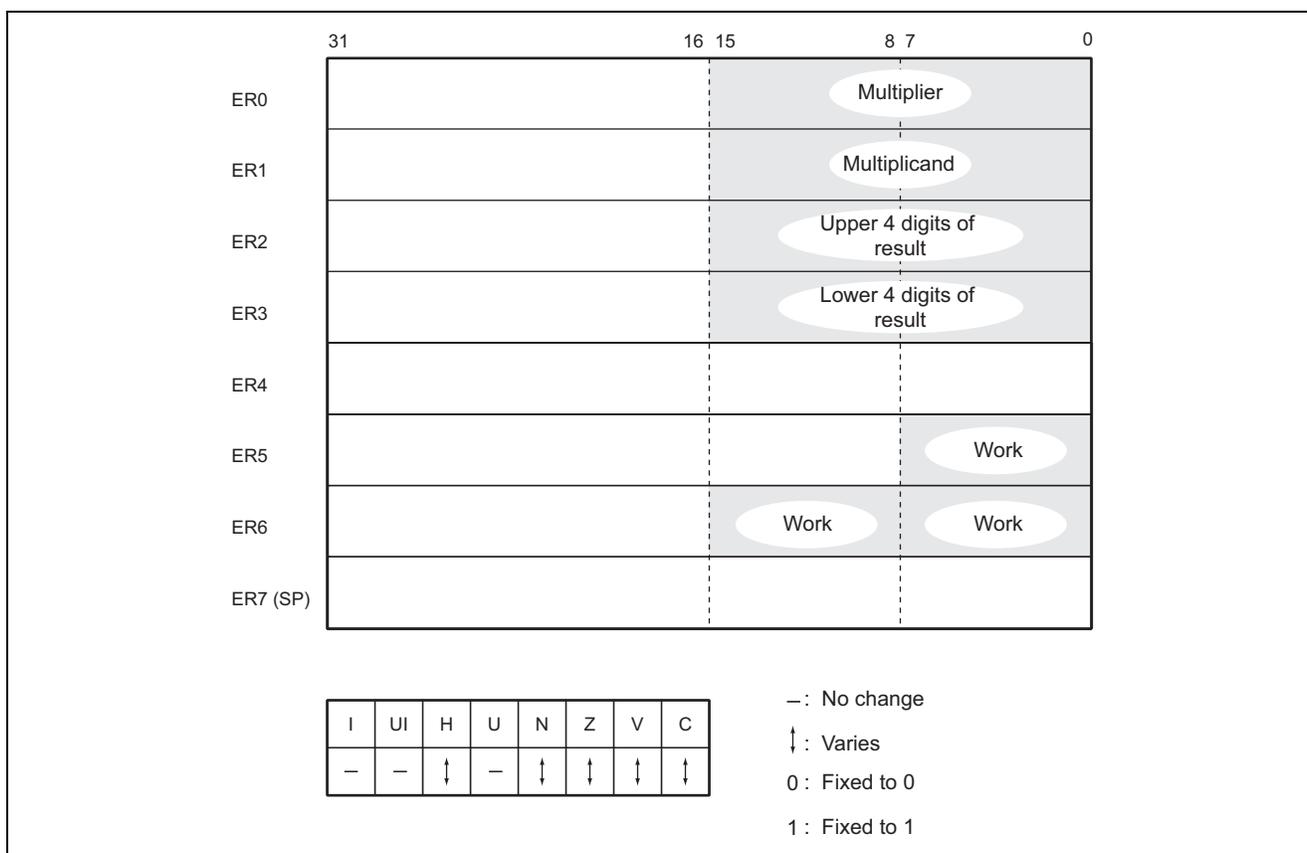
### 1. Function

1. Multiplies two four-digit BCD (binary-coded-decimal) numbers, and sets the result (eight-digit BCD) in general registers.
2. The arguments are all unsigned integers.
3. Data operations are entirely within the general registers.

### 2. Arguments

Contents	Storage Location	Data Length (Bytes)
Input    Multiplicand	R1	2
Multiplier	R0	2
Output   Result	R2, R3	4

### 3. Changes to Internal Registers and Flags



#### 4. Programming Specifications

Program memory (bytes)	62
Data memory (bytes)	0
Stack (bytes)	0
Number of cycles	1192
Re-entrant	Yes
Relocatable	Yes
Interrupts during execution	Yes

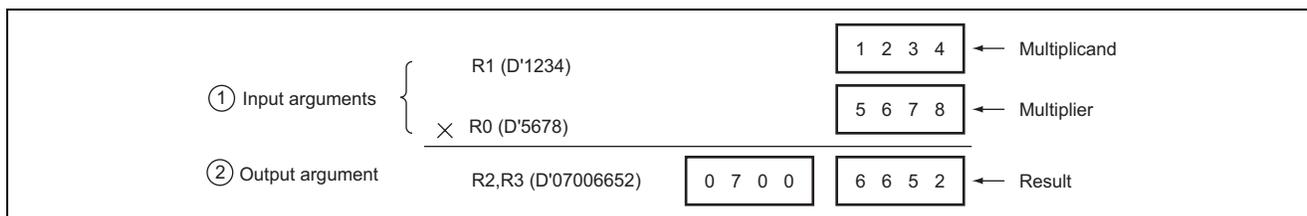
#### 5. Note

The number of cycles in the programming specifications is the value for calculating  $9999 \times 9999$ .

### 6. Description

#### 6.1 Description of Functions

- The arguments are as follows.
  - R0: Set the 4-digit BCD multiplier (16 bits) as an input argument.
  - R1: Set the 4-digit BCD multiplicand (16 bits) as an input argument.
  - R2: The higher-order four digits of the 8-BCD-digit (32 bit) product are placed here as an output argument.
  - R3: The lower-order four digits of the result are placed here.
- The following figure illustrates the execution of the MULD subroutine. When the input arguments are set as shown below, the product is placed in R2 and R3.



**Figure 1 Example of MULD Execution**

- The subroutine always returns zero if either or both of the inputs are zero.

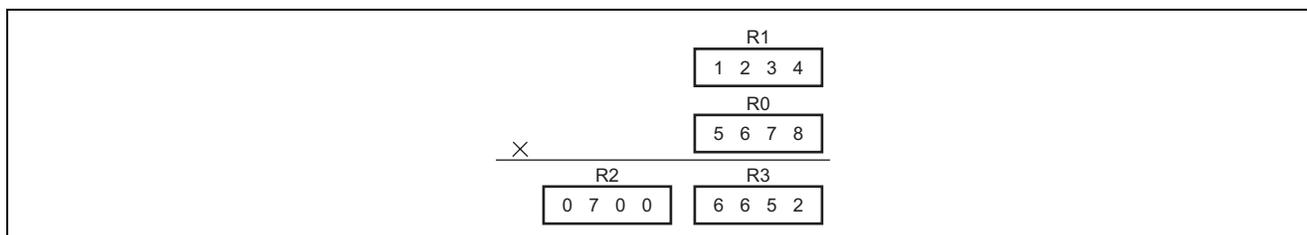
**Table 1 Results When "0" Is Set As the Input Argument**

Input Argument		Output Argument
Multiplicand (R1)	Multiplier (R0)	Product (R2, R3)
H'****	H'0000	H'00000000
H'0000	H'****	H'00000000
H'0000	H'0000	H'00000000

Note: H'\*\*\*\* refers to a hexadecimal number.

#### 6.2 Usage Notes

- When any upper digit of an input argument is not used, the "0" must be explicitly set in the digit, as is shown in figure 2. Otherwise, the correct result might not be obtained because the undefined data in the upper digits is included in the multiplication.



**Figure 2 Multiplication When the Upper Digits are not Used**

- The multiplier placed in R0 will be lost in the execution of MULD. When you will still require the multiplier, save it elsewhere in memory beforehand.

### 6.3 Description of Data Memory

No data memory is used by MULD.

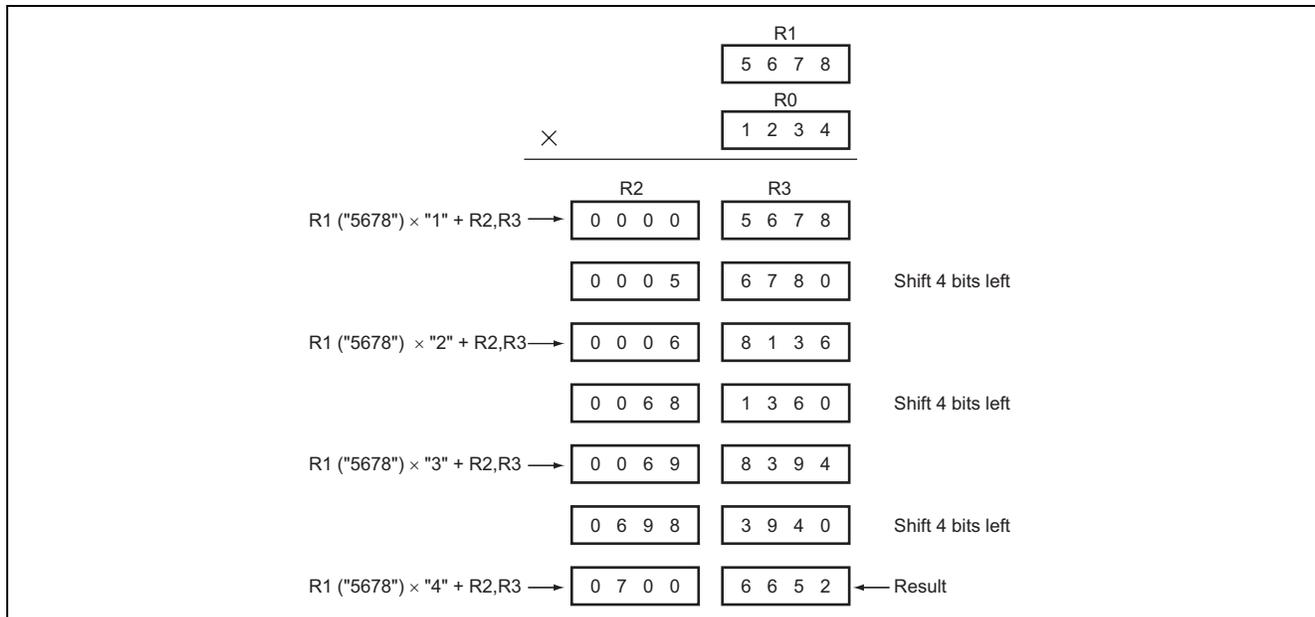
### 6.4 Example of Usage

After setting the multiplicand and multiplier, call the MULD subroutine.

WORK1	. RES. W 1	.....	Reservation of the data memory area for setting of the 4-digit BCD multiplicand by the user program.
WORK2	. RES. W 1	.....	Reservation of the data memory area for setting of the 4-digit BCD multiplier by the user program.
WORK3	. RES. W 2	.....	Reservation of the data memory area to hold the 8-digit BCD multiplication result for the user program.
	.		
	.		
	MOV. W @WORK1, R1	.....	Sets, as an input argument for MULD, the 4-digit BCD multiplicand specified by the user program.
	MOV. W @WORK2, R0	.....	Sets the 4-digit BCD multiplier specified by the user program.
	<span style="border: 1px solid black; padding: 2px;">JSR @MULD</span>	.....	Subroutine call of MULD.
	MOV. W R2, @WORK3	.....	Transfers the 8-digit BCD result from the output argument to the data memory of the user program.
	MOV. W R3, @WORK3+2		
	.		
	.		

### 6.5 Principles of Operation

1. Decimal multiplication is done by repeated addition. The following figure shows the multiplication  $5678 \times 1234$  as an example.



**Figure 3 Multiplication (5678 × 1234)**

Figure 6.3 illustrates the method used to find the product by repeatedly adding the multiplicand, multiplied by the respective digits of the multiplier from the leftmost digit, to the result and then shifting the result.

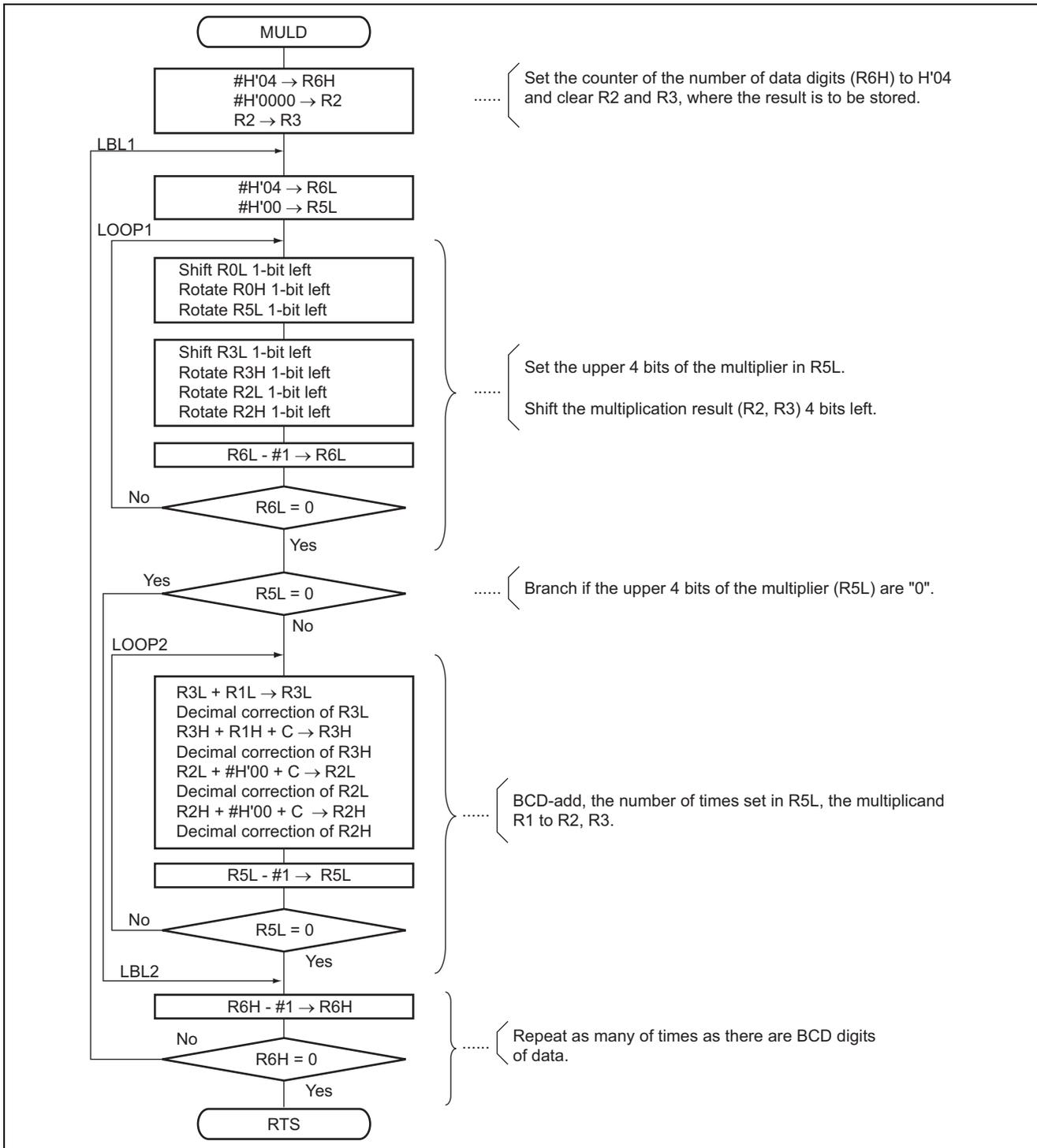
Firstly, the highest-order BCD digit (four bits) of the multiplier is taken, and the multiplicand is added this number of times. The result is then shifted four bits to the left (one BCD digit). Next, the second highest digit is taken from the multiplier, the multiplicand is added to the preceding result this number of times, and so on. The final result is found by repeating the processes as many times as there are BCD digits (four).

2. Details of the program are given below.

The program:

- 1) places H'04 in R6H as a counter that indicates the number of BCD digits in the data;
- 2) clears R2 and R3, where the result of multiplication is to be stored;
- 3) shifts R2 and R3 four bits (one BCD digit) left;
- 4) loads one BCD digit from the higher-order end of the multiplier to R5L, and branches to step 6) if R5L is "0";
- 5) BCD-adds the multiplicand to R2, R3 the same number of times as the value in R5L;
- 6) decrements R6H; and
- 7) repeats steps 3) to 6) above until R6H has become "0".

7. Flowchart



## 8. Program Listing

```

1          1          ;*****
2          2          ;*
3          3          ;*          NAME : DECIMAL MULTIPLICATION          *
4          4          ;*          (MULD)          *
5          5          ;*
6          6          ;*****
7          7          ;*
8          8          ;*          ENTRY:  R1          (MULTIPLICAND)          *
9          9          ;*          R0          (MULTIPLIER)          *
10         10         ;*
11        11        ;*          RETURN: R2          (UPPER WORD OF RESULT)          *
12        12        ;*          R3          (LOWER WORD OF RESULT)          *
13        13        ;*
14        14        ;*****
15        15        ;
16        16        .CPU          300HN
17 0000    17        .SECTION    MULD_code, CODE, ALIGN=2
18        18        .EXPORT    MULD
19        19        ;
20          20        MULD .EQU    $          ;Entry point
21 0000 F604    21        MOV.B    #H'04,R6H ;Set the bcd digit counter
22 0002 79020000 22        MOV.W    #H'0000,R2 ;Clear R2
23 0006 0D23    23        MOV.W    R2,R3 ;Clear R3
24        24        ;
25 0008    25        LBL1
26 0008 FE04    26        MOV.B    #H'04,R6L ;Set bit counter
27 000A FD00    27        MOV.B    #H'00,R5L ;Clear R5L
28 000C    28        LOOP1
29 000C 1008    29        SHLL.B    R0L ;Shift multiplier 1 bit left
30 000E 1200    30        ROTXL.B    R0H
31 0010 120D    31        ROTXL.B    R5L
32 0012 100B    32        SHLL.B    R3L ;Shift result 1 bit left
33 0014 1203    33        ROTXL.B    R3H
34 0016 120A    34        ROTXL.B    R2L
35 0018 1202    35        ROTXL.B    R2H
36 001A 1A0E    36        DEC.B    R6L ;Decrement bit counter
37 001C 46EE    37        BNE     LOOP1 ;Branch if Z=0
38 001E AD00    38        CMP.B    #H'00,R5L
39 0020 4714    39        BEQ     LBL2 ;Branch if Z=1
40 0022    40        LOOP2
41 0022 089B    41        ADD.B    R1L,R3L ;R1L + R3L --> R1L
42 0024 0F0B    42        DAA.B    R3L ;Decimal adjust R3L
43 0026 0E13    43        ADDX.B    R1H,R3H ;R1H + R3H + C --> R1H
44 0028 0F03    44        DAA.B    R3H ;Decimal adjust R3H
45 002A 9A00    45        ADDX.B    #H'00,R2L ;R2L + #H'00 + C --> R2L
46 002C 0F0A    46        DAA.B    R2L ;Decimal adjust --> R2L
47 002E 9200    47        ADDX.B    #H'00,R2H ;R2H + #H'00 + C --> R2H
48 0030 0F02    48        DAA.B    R2H ;Decimal adjust R2H
49 0032 1A0D    49        DEC.B    R5L ;Clear bit 0 of R5L
50 0034 46EC    50        BNE     LOOP2 ;Branch if Z=0
51 0036    51        LBL2
52 0036 1A06    52        DEC.B    R6H ;Decrement bcd digit counter

```

```
53 0038 46CE          53          BNE      LBL1      ;Branch if Z=0
54                    54          ;
55 003A 5470          55          RTS
56                    56          .END
*****TOTAL ERRORS      0
*****TOTAL WARNINGS    0
```

### Revision Record

Rev.	Date	Description	
		Page	Summary
2.00	Feb.28.06	—	Format has been changed from Hitachi version to Renesas version.

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